

FIG. 1

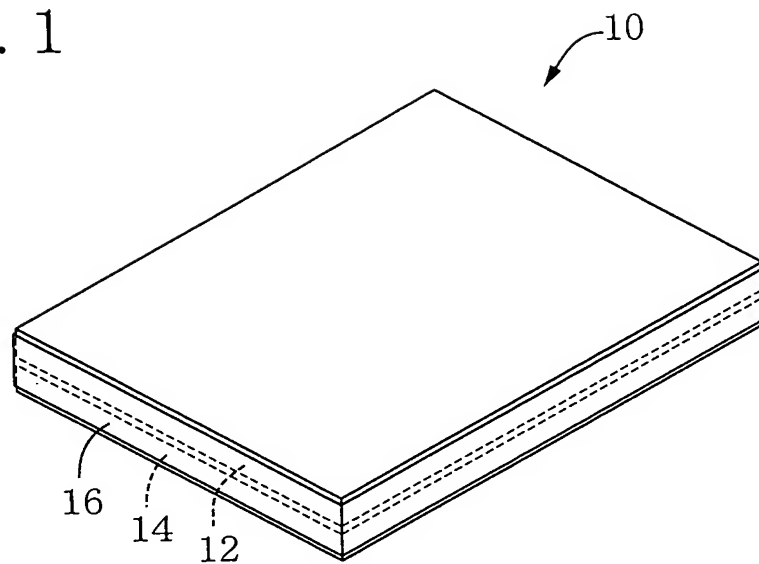


FIG. 2

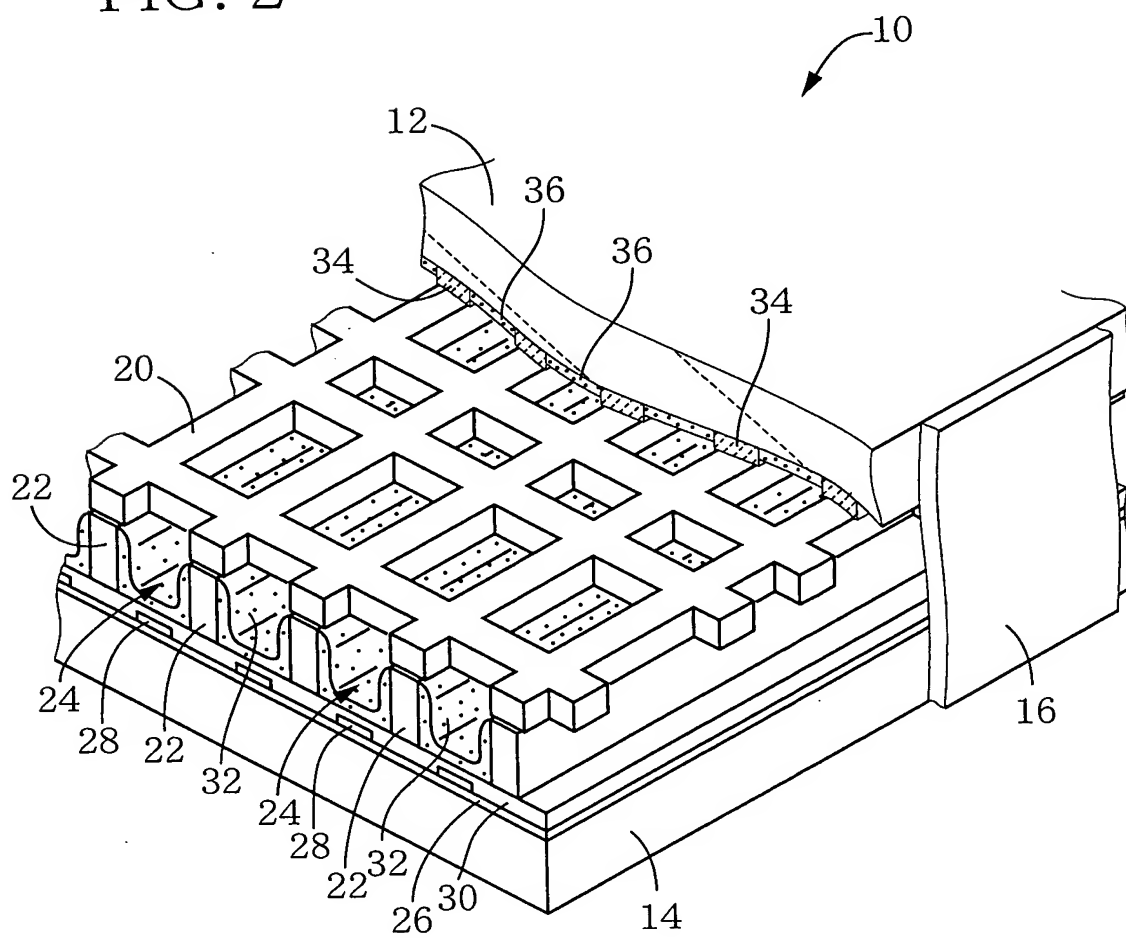


FIG. 3

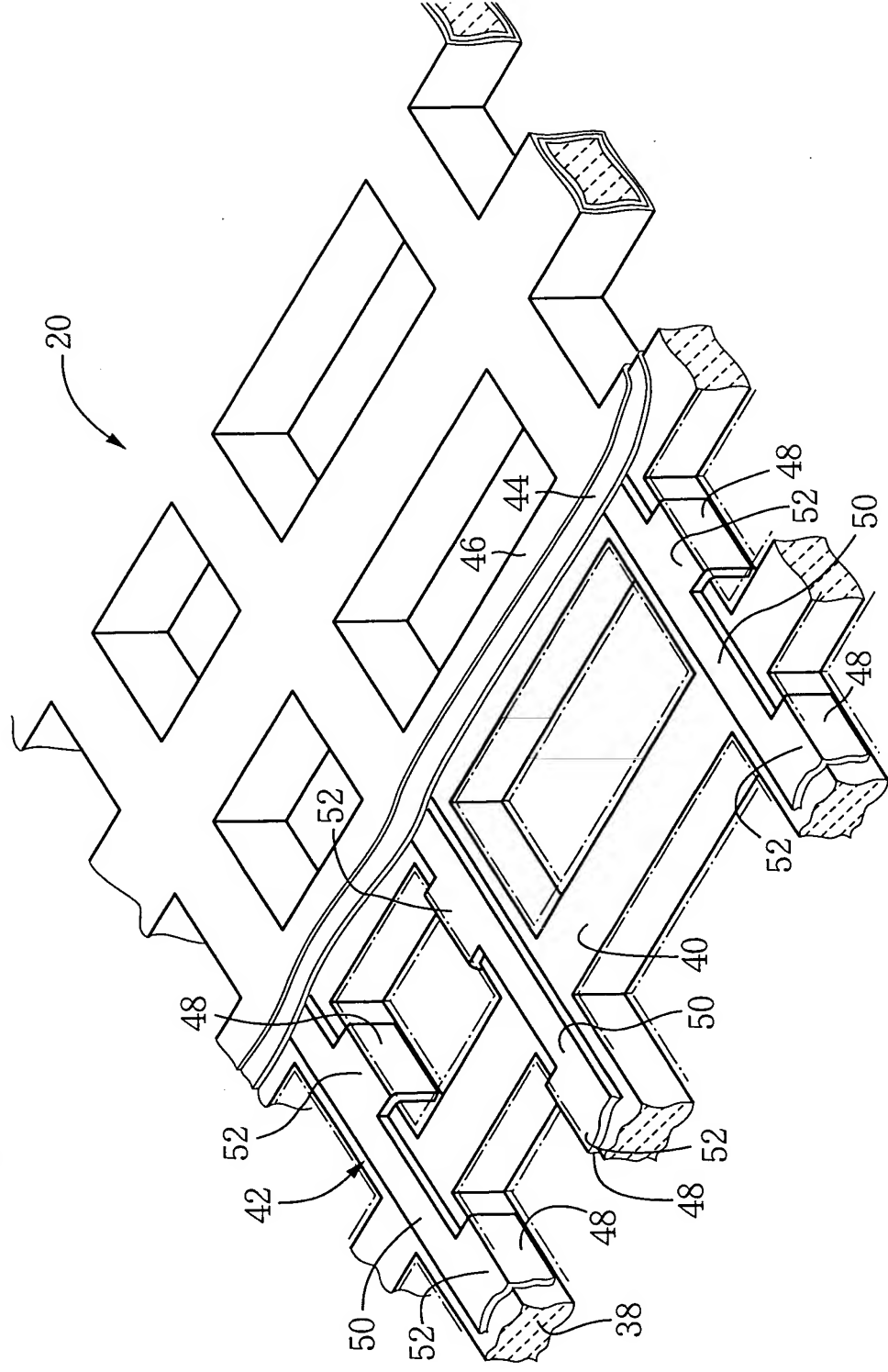




FIG. 6

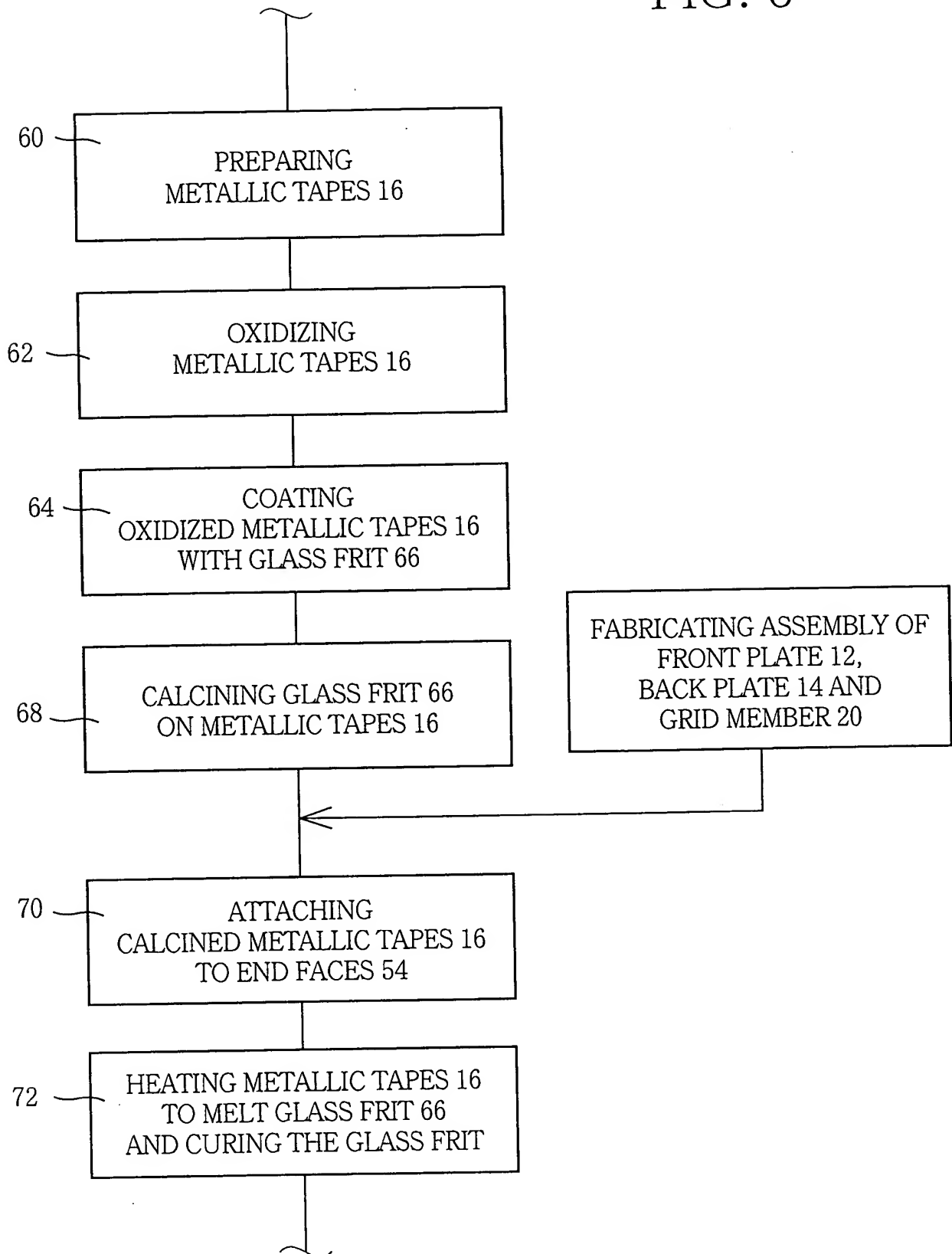


FIG. 7A

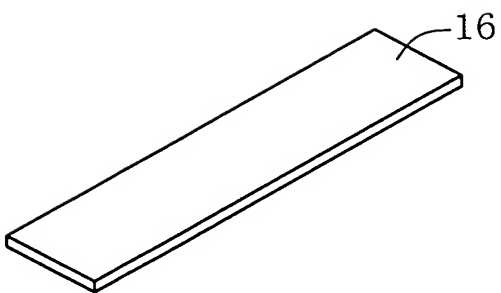


FIG. 7B

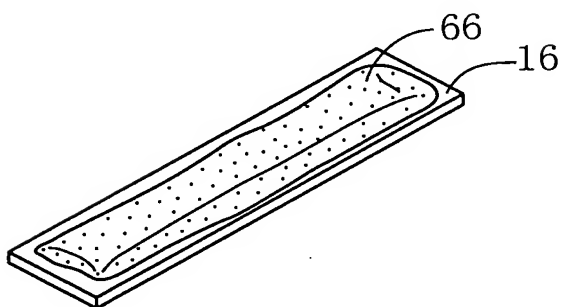


FIG. 7C

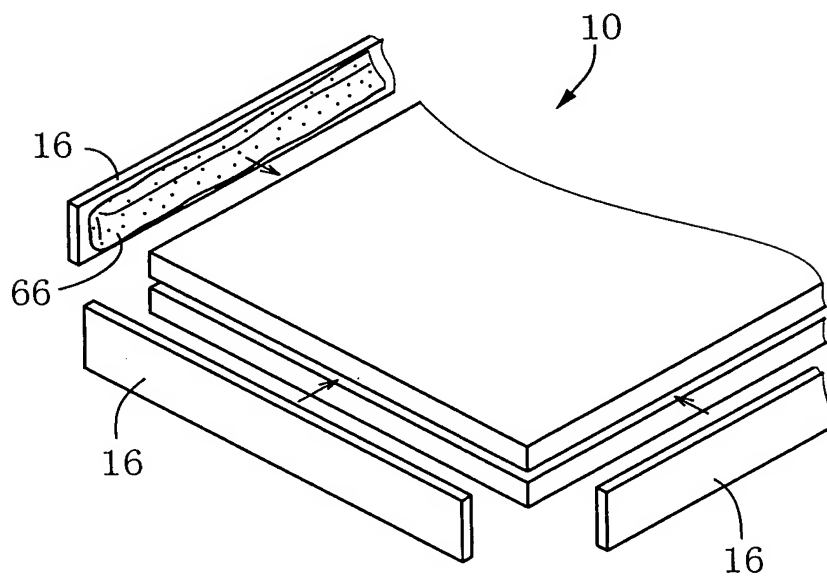


FIG. 8

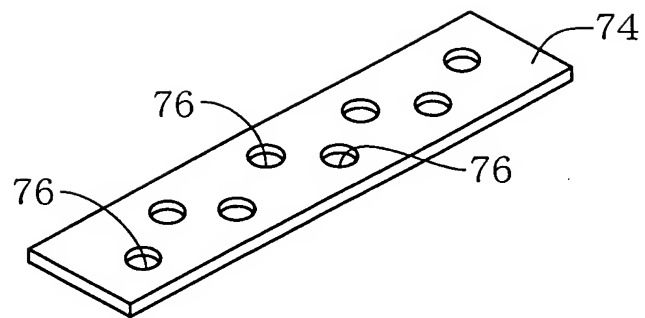


FIG. 9A

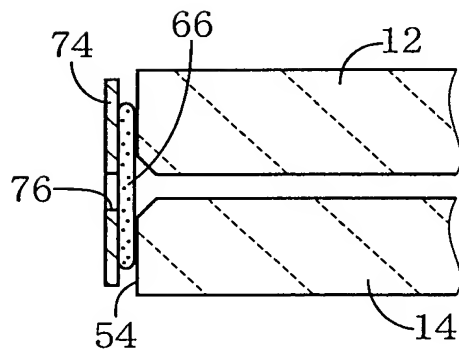


FIG. 9B

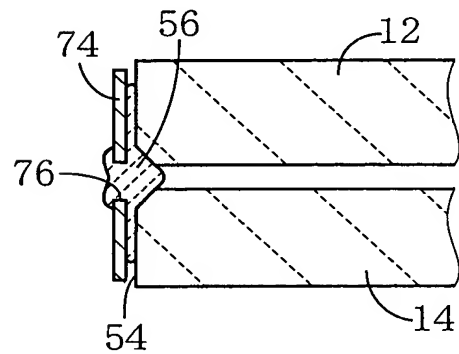


FIG. 10A

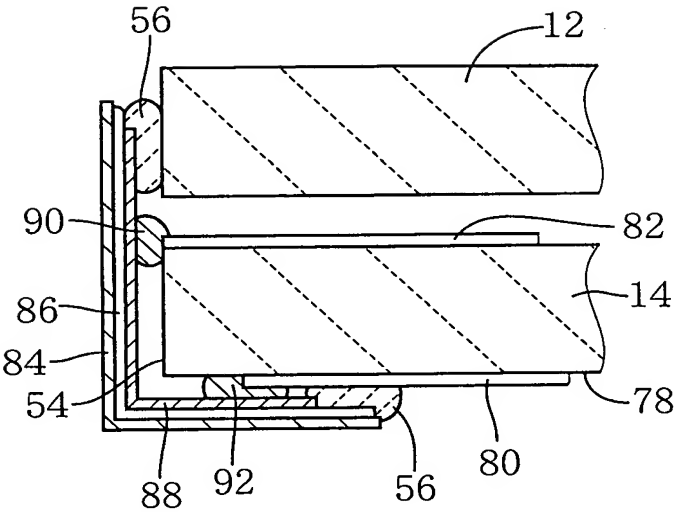


FIG. 10B

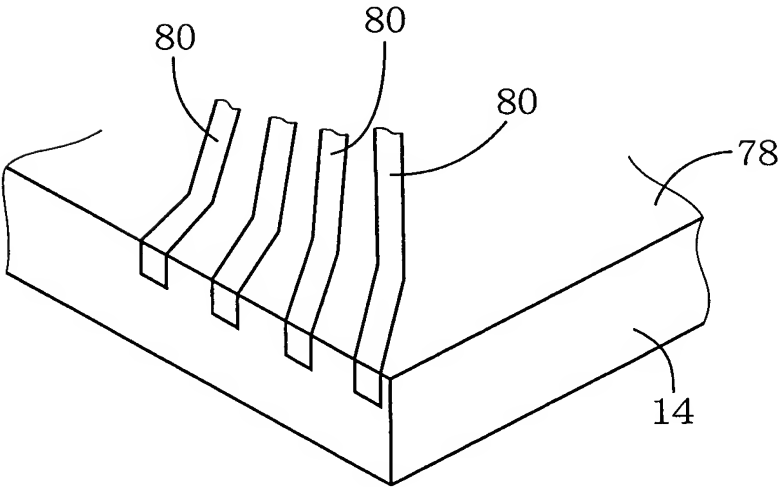
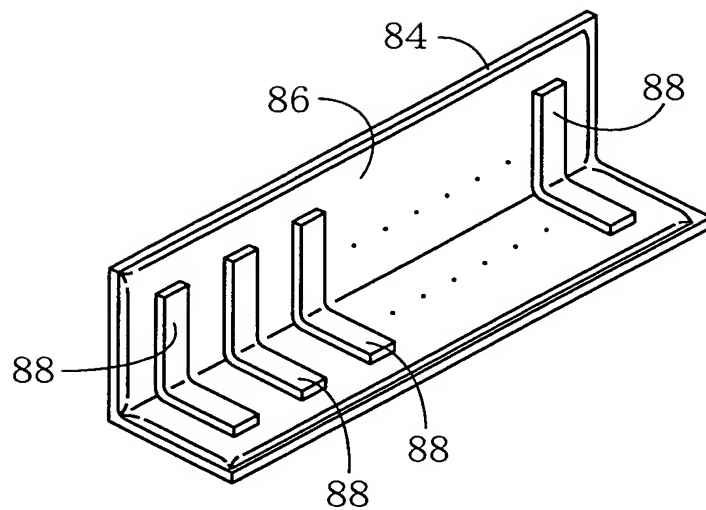


FIG. 11





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graph TD
    60[60 PREPARING METALLIC TAPE 84] --> 94[94 BENDING METALLIC TAPE 84]
    94 --> 62[62 OXIDIZING METALLIC TAPE 84]
    62 --> 96[96 FORMING DIELECTRIC LAYER 86 ON OXIDIZED TAPE 84]
    96 --> 98[98 FORMING LEAD CONDUCTORS 88 ON DIELECTRIC LAYER 86]
    98 --> 64[64 COATING OXIDIZED METALLIC TAPE 84 WITH GLASS FRIT 66]
    64 --> 68[68 CALCINING GLASS FRIT 66 ON METALLIC TAPE 84]
    68 --> 100[100 APPLYING CONDUCTIVE PASTE 102 TO LEAD CONDUCTORS 88]
    100 --> 70[70 ATTACHING CALCINED METALLIC TAPE 84 TO END FACES 54]
    70 --> 72[72 HEATING METALLIC TAPE 84 TO FIRE GLASS FRIT 66 AND PASTE 102]
    72 --> 74[74 FABRICATING ASSEMBLY OF FRONT PLATE 12, BACK SHEET 14 AND GRID MEMBER 20]

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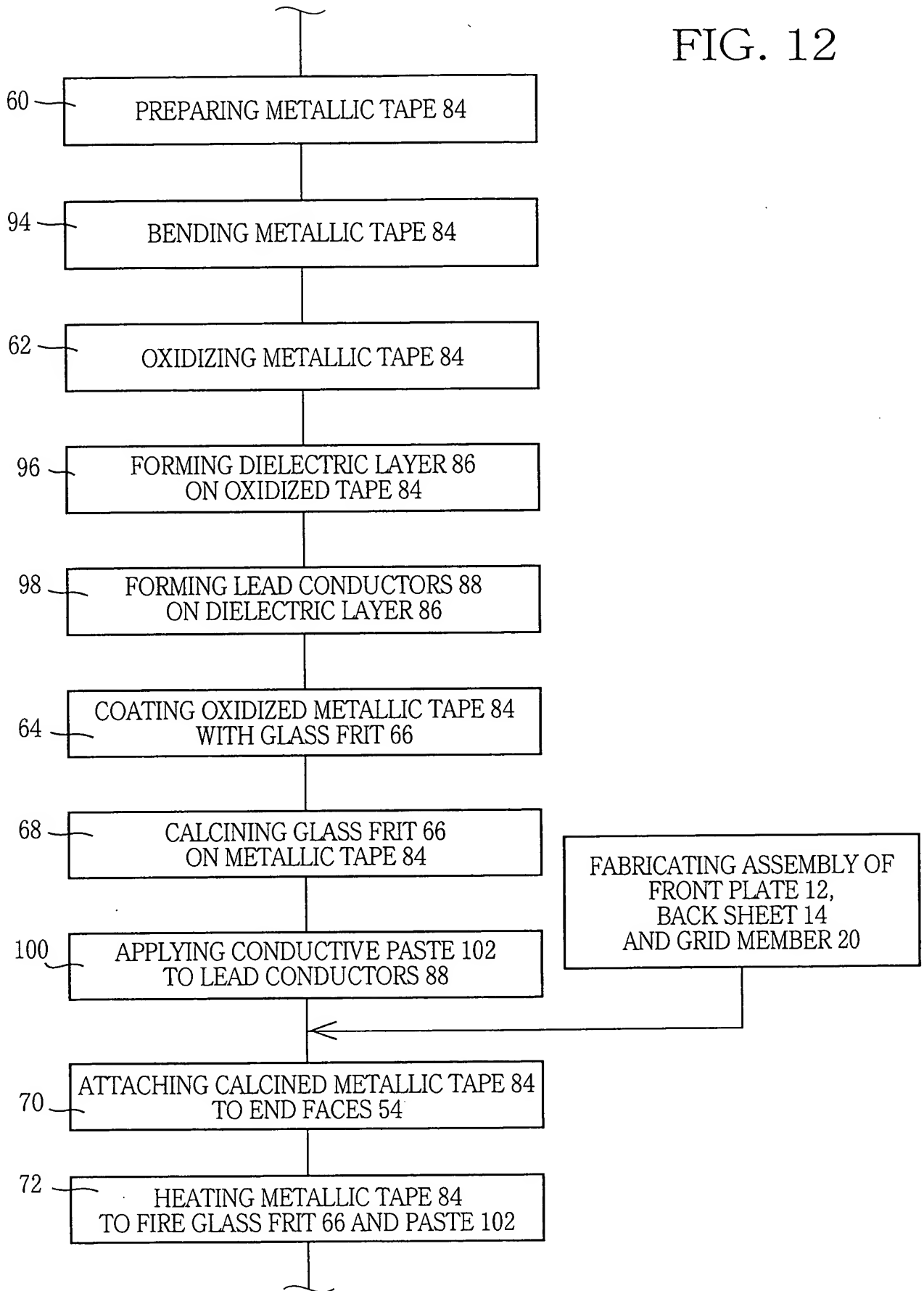


FIG. 13A

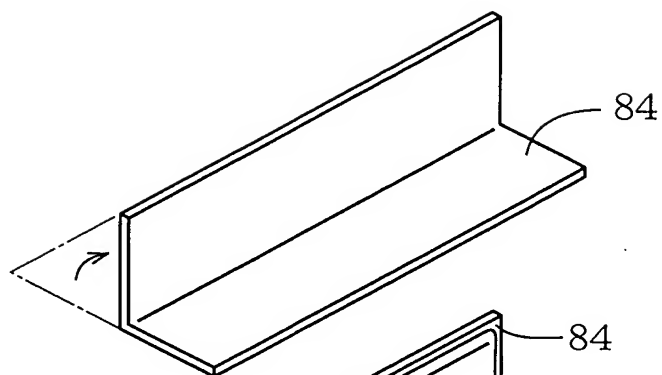


FIG. 13B

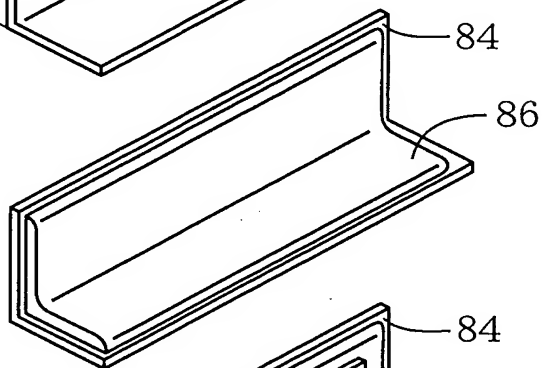


FIG. 13C

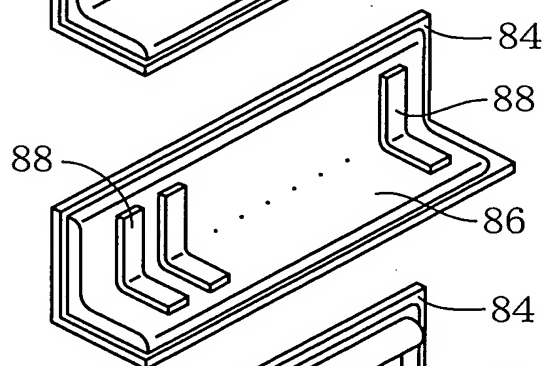


FIG. 13D

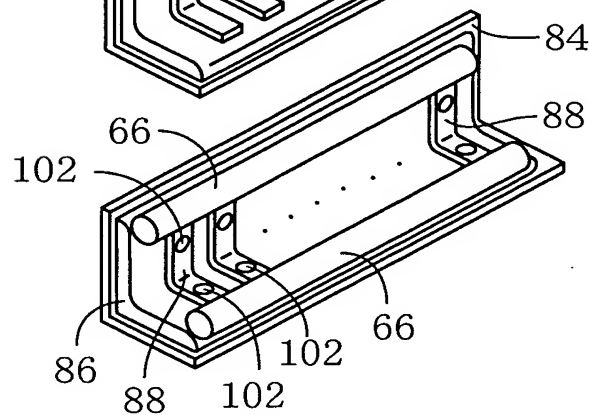


FIG. 13E

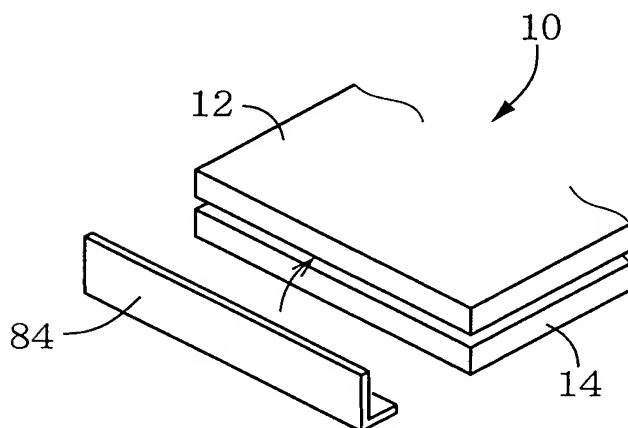


FIG. 14

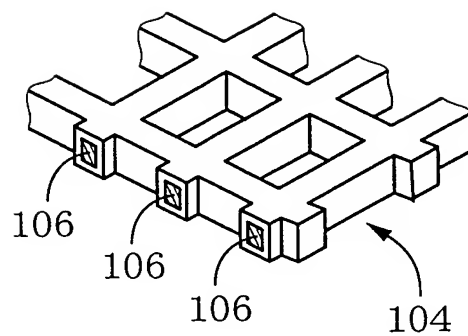


FIG. 15

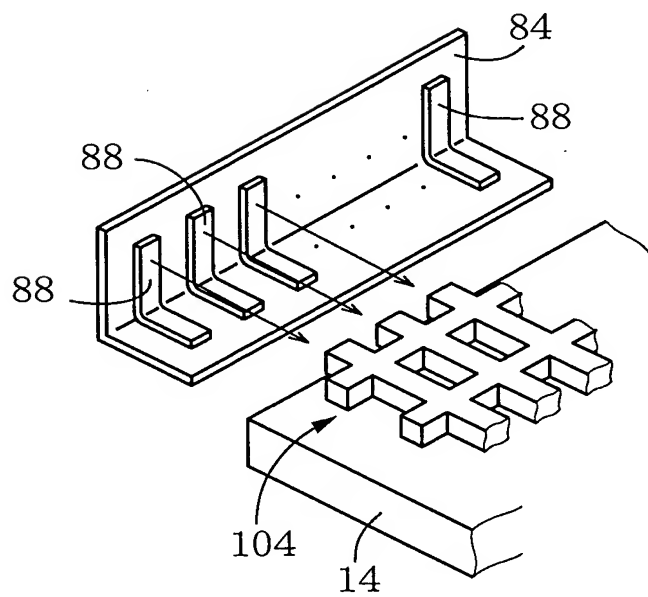


FIG. 16A

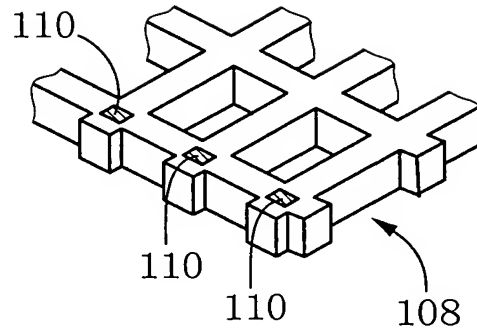


FIG. 16B

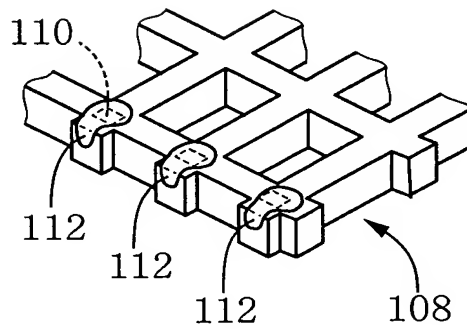


FIG. 17

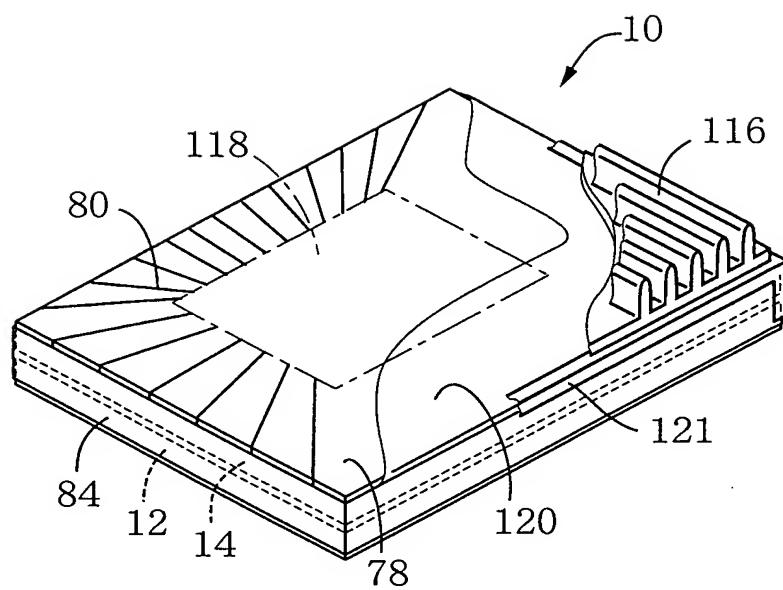


FIG. 18

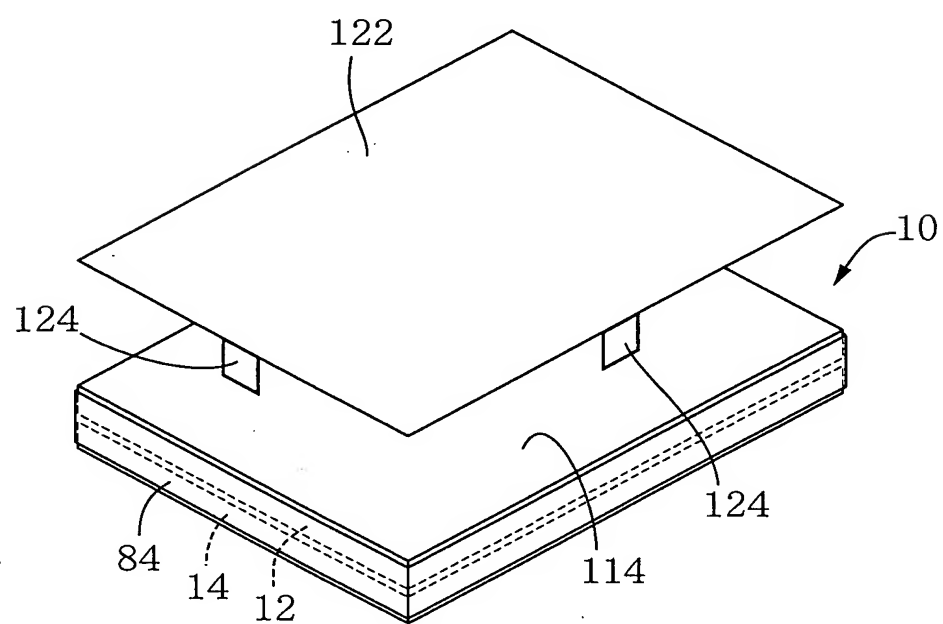


FIG. 19

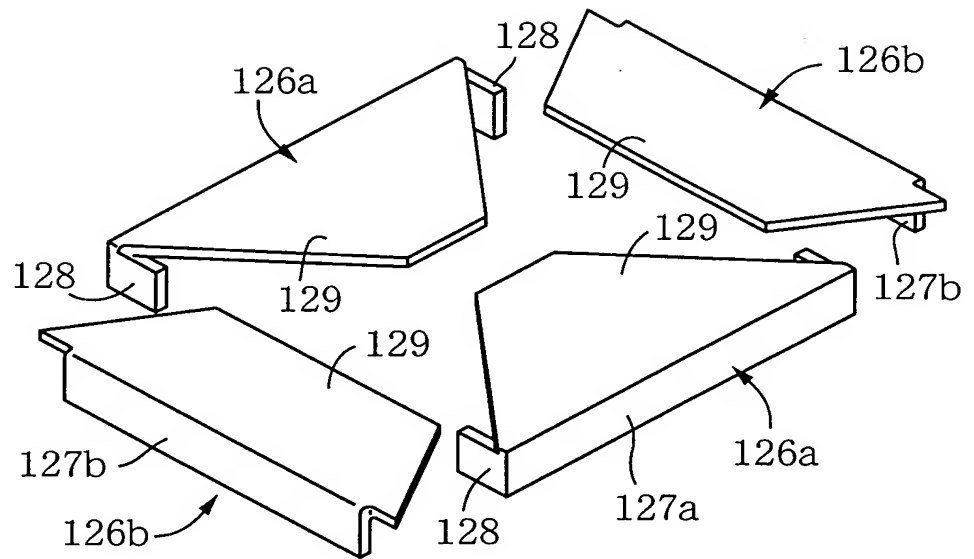


FIG. 20

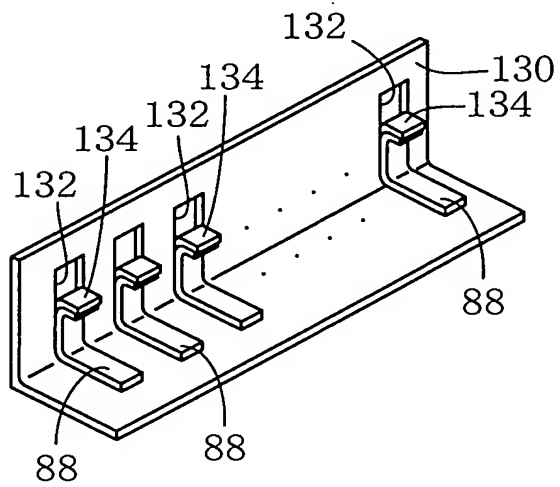


FIG. 21

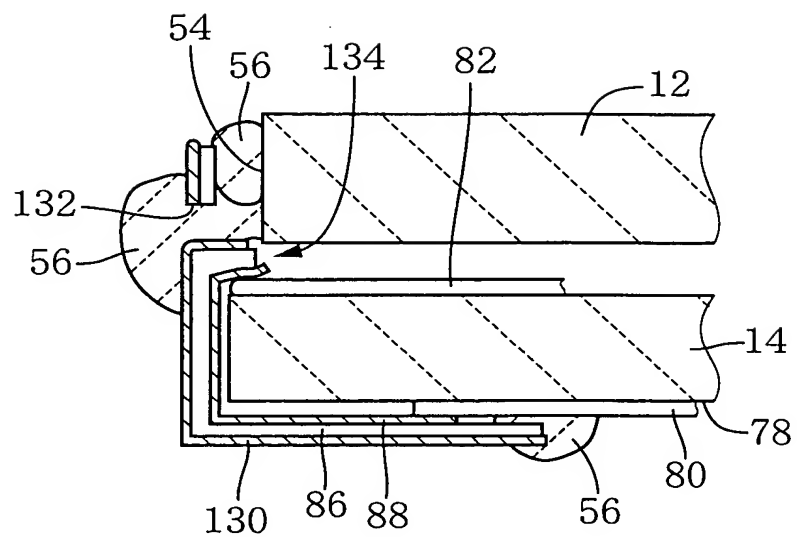


FIG. 22

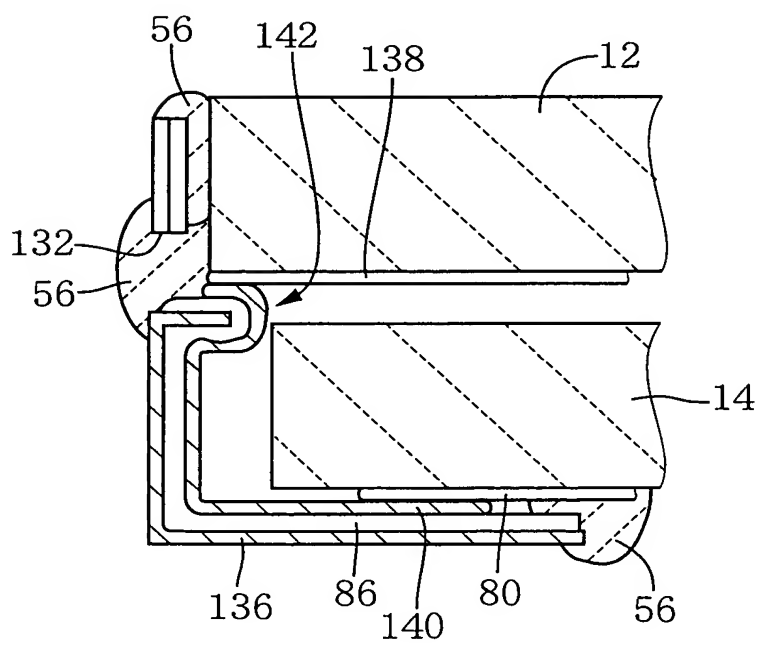


FIG. 23

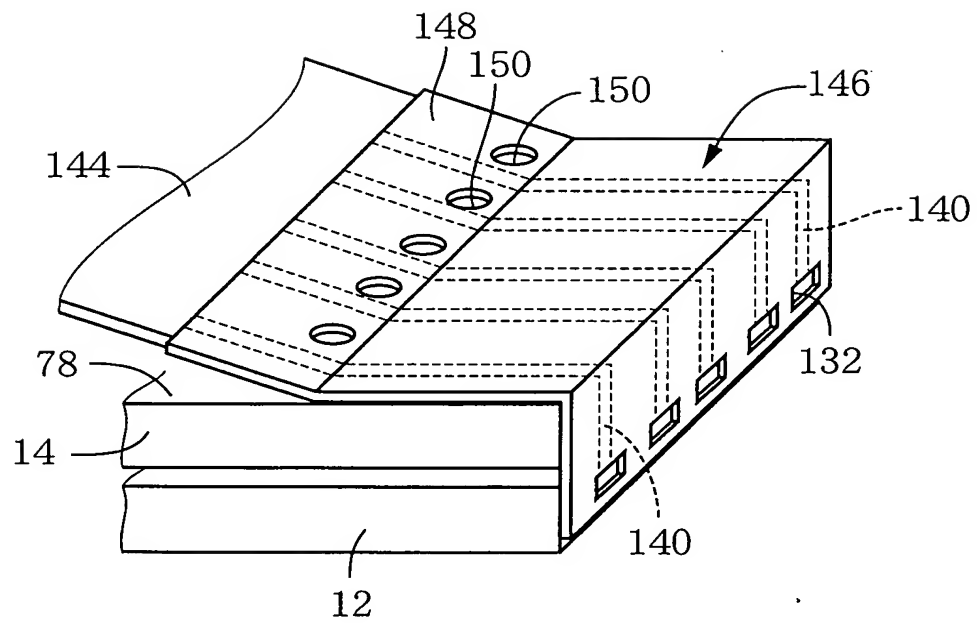


FIG. 24

